IPC ASSOCIATION CONNECTINE ELECTRONICS INDUSTRIE	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					ials and Mfc Information				
upplier Inforn															
Company name*			Company unique ID			J	Unique ID Authority					Response Date*			
nsemi										2023-06-08					
Contact Name		Title - Contact			I	Phone - Contact*				Email - Contact*					
Product-Env-Stewa	ards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
uthorized Represe	entative*	Title - Representative			I	Phone - Representative*				Email - Representative*					
Product-Env-Stewa	ards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
Requeste	er Item Number			Mfr Item Name			Effective Dat	e Versi	on	Manufacturing Site		Weight*	UOM	Unit Type	
				SO5 3.3V 10MB 7	3.3V 10MB T&R		2023-06-08			LITEONFG		97.594	mg	Each	
Ianufacturing	Proccess Information	on													
Terminal Plating / Grid Array Material T			Terminal Base Alloy J-STD-020 MSI		SL Rating	Peak Process Body Tempera		/ Temperatu			ure Numb	er of Reflow Cyc	eles		
Matte Tin (Sn) - annealed			CU Alloy 1				260 C 30			seconds 3					
omments															
vel 1 - maximum t	ime at peak temperatur	e during sol	dering is 10-3	30 seconds											
or more informati	on regarding material co	omposition j	please refer t	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale appl										
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted					
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the					

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Coupling Gel	8.8	mg	Supplier	Titanium Dioxide (TiO2)	13463-67-7		3.96	mg
			Supplier	Dimethyl Cyclosiloxanes	69430-24-6		0.88	mg
			Supplier	Trimethoxy(methyl)silane (C4H12O3Si)	1185-55-3		3.96	mg
Die	0.237	mg	В	Gallium Arsenide (AsGa)	1303-00-0		0.077	mg
			Supplier	Silicon (Si)	7440-21-3		0.16	mg
Die Attach	0.009	mg	Supplier	Silver (Ag)	7440-22-4		0.007	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.002	mg
Lead Frame	17.018	mg	Supplier	Silver (Ag)	7440-22-4		0.002	mg
			Supplier	Zinc (Zn)	7440-66-6		0.02	mg
			Supplier	Iron (Fe)	7439-89-6		0.391	mg
			Supplier	Copper (Cu)	7440-50-8		16.6	mg
			Supplier	Phosphorus (P)	7723-14-0		0.005	mg
Mold Compound-Black	70.32	mg	Supplier	2,6-dibromo-4-[1-(3-bromo-4-hydroxyphenyl)-1-methylethyl]phenol	6386-73-8		2.81	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		16.2	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		2.11	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		49.2	mg
Plating	1.16	mg	Supplier	Tin (Sn)	7440-31-5		1.16	mg
Wire Bond - Au	0.05	mg	Supplier	Gold (Au)	7440-57-5		0.05	mg